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PATENT
Atty Docket No.: 10004808-1

In The U.S. Patent and Trademark Office

In Re the Application of:

Inventor(s): Osamu S. Nakagawa et al. **Confirmation No.:** 3635
Serial No.: 09/891,324 **Examiner:** Schillinger, Laura M.
Filed: June 27, 2001 **Group Art Unit:** 2813
Title: PROCESS FOR HIGH-DIELECTRIC CONSTANT METAL-INSULATOR
METAL CAPACITOR IN VLSI MULTI-LEVEL METALIZATION SYSTEMS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

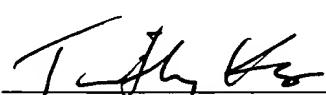
CERTIFICATE OF HAND-DELIVERY WITH THE USPTO

I hereby certify that this correspondence is being deposited with the United States Patent and Trademark Office. This correspondence contains the following document(s):

1 sheet of Transmittal Letter for Response/Amendment. (2 copies).
9 sheets of Amendment Under 37 C.F.R. § 1.111.

Respectfully submitted,

MANNAVA & KANG, P.C.



Timothy B. Kang
Reg. No.: 46,423

On May 24, 2004

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UNITED STATES PATENT AND TRADEMARK OFFICE

Osamu S. Nakagawa et al.

Confirmation No.: 3635

Application No.: 09/891,324

Examiner: Laura Schillinger

Filing Date: June 27, 2001

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Title: PROCESS FOR HIGH-DIELECTRIC CONSTANT METAL-INSULATOR METAL CAPACITOR
IN VLSI MULTI-LEVEL METALIZATION SYSTEMS

Commissioner for Patents

PO Box 1450

Alexandria, VA 22313-1450

TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

Sir:

Transmitted herewith is/are the following in the above-identified application:

(X) Response/Amendment () Petition to extend time to respond
 () New fee as calculated below () Supplemental Declaration
 (X) No additional fee (Address envelope to "Mail Stop Non-Fee Amendment")
 () Other: _____ (fee \$ _____)

CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY						
(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	(4) HIGHEST NUMBER PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEES
TOTAL CLAIMS	13	MINUS	20	= 0	X \$18	\$ 0
INDEP. CLAIMS	1	MINUS	3	= 0	X \$86	\$ 0
[] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						+ \$290
EXTENSION FEE	1ST MONTH \$110.00	2ND MONTH \$420.00	3RD MONTH \$950.00	4TH MONTH \$1480.00		\$ 0
OTHER FEES						\$
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$ 0

Charge \$ 0 to Deposit Account 08-2025. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 08-2025 under 37 CFR 1.16 through 1.21 inclusive, and any other sections in Title 37 of the Code of Federal Regulations that may regulate fees. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

Osamu S. Nakagawa et al.

By

Timothy B. Kang

Attorney/Agent for Applicant(s)
Reg. No. 46,423

Date of Deposit:

Typed Name:

Signature: _____

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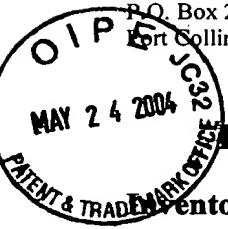
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MAIL STOP NON-FEE AMENDMENT

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AMENDMENT UNDER 37 C.F.R. § 1.111

Sir:

In response to the Official Action dated February 25, 2004, kindly amend the application identified above as follows. In the following, underlines indicate additions and strikethroughs indicate deletions.